

www.ti.com

SLTS261C -MAY 2006-REVISED SEPTEMBER 2009

100-W 48-V INPUT ISOLATED DC/DC CONVERTER

Check for Samples: PTQA430025, PTQA430033, PTQA420050

FEATURES

- 100-W Output
- Input Voltage Range: 36 V to 75 V
- 92% Efficiency
- 1500 Vdc Isolation
- Fast Transient Response
- On/Off Control
- Overcurrent Protection
- Differential Remote Sense
- Adjustable Output Voltage
- Output Overvoltage Protection
- Over-Temperature Shutdown
- Undervoltage Lockout
- Standard 1/4-Brick Footprint
- UL Safety Agency Approval



DESCRIPTION

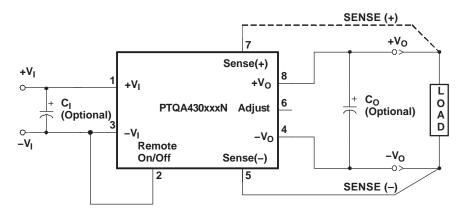
The PTQA series of power modules are single-output isolated DC/DC converters, housed in an industry standard quarter-brick package. These modules are rated up to 100W with a maximum load current of up to 30 A.

The PTQA series operates from a standard 48-V telecom central office (CO) supply and occupies only 3.3 in² of PCB area. The modules offer OEMs a compact and flexible high-output power source in an industry standard footprint. They are suitable for distributed power applications in both telecom and computing environments, and may be used for powering high-end microprocessors, DSPs, general purpose logic and analog.

Features include a remote On/Off control with optional logic polarity, an undervoltage lockout (UVLO), a differential remote sense, and an industry standard output voltage adjustment using an external resistor. Protection features include output overcurrent protection (OCP), overvoltage protection (OVP), and thermal shutdown (OTP).

The modules are fully integrated for stand-alone operation, and require no additional components.

STANDARD APPLICATION





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



SLTS261C -MAY 2006-REVISED SEPTEMBER 2009

www.ti.com



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION

For the most current package and ordering information, see the Package Option Addendum at the end of this datasheet, or see the TI website at www.ti.com.

Table 1. PART NUMBERING SCHEME

	Input Voltage	Output Current	Output Voltage	Enable	Electrical Options		Pin Style
PTQA	4	30	033	N	2	Α	D
	4 = 48 V	30 = 30A	025 = 2.5 V	N = Negative	2 = V _O Adjust		D = Through-hole, Pb-free
		20 = 20A	033 = 3.3 V	P = Positive			S = SMD, SnPb solder ball
			050 = 5.0 V				Z = SMD, SnAgCu solder ball

ABSOLUTE MAXIMUM RATING

				UNIT	
T _A	Operating Temperature Range	Over V _I Range		-40°C to 85°C ⁽¹⁾	
$V_{I,}$	Maximum lanut Valtana	Continuous voltage		80 V	
MAX	Maximum Input Voltage	Peak voltage for 100 ms duration	100 V		
			PTQA420050x2		
P _O ,	Po. Maximum Output Power		100 W		
MAX			PTQA430025x2		
T _S	Storage Temperature			-40°C to 125°C	
	Machaniaal Charle	Per Mil-STD-883, Method 2002.3 1 ms, 1/2	AD Suffix	250 G	
	Mechanical Shock	Sine, mounted	AS or AZ Suffix	175 G	
	Machaniaal Vibraniaa	Per Mil-STD-883, Method 2007.2 20-2000 Hz,	AD Suffix	15 G	
	Mechanical Vibrarion	PCB mounted	AS or AZ Suffix	2.5 G	
	Weight			30 grams	
	Flammability	Meets UL 94V-O			

(1) See SOA curves or consult factory for appropriate derating.

Submit Documentation Feedback

Copyright © 2006–2009, Texas Instruments Incorporated



www.ti.com

SLTS261C -MAY 2006-REVISED SEPTEMBER 2009

ELECTRICAL CHARACTERISTICS PTQA430025

(Unless otherwise stated, T_A =25°C, V_I = 48 V, V_O = 2.5 V, C_O = 0 μF , and I_O = I_O max)

PARAMETER		TEST COMPITIONS			PTQA430025				
	PARAMETER	TEST CONDITIONS			TYP	TYP MAX			
Io	Output Current	Over V _I range		0		30	Α		
VI	Input Voltage Range	Over I _O Range		36	48	75	V		
V _O tol	Set Point Voltage Tolerance				±1 ⁽¹⁾		%V _O		
Reg _{temp}	Temperature Variation	-40°C >T _A > 85°C			±1.15		%V _O		
Reg _{line}	Line Regulation	Over V _I range			±5		mV		
Reg _{load}	Load Regulation	Over I _O range			±5		mV		
ΔV_{o} tot	Total Output Voltage Variation	Includes set-point, line, load, -4	40°C >T _A > 85°C		±1.5	±3	%V _O		
ΔV_{ADJ}	Output Adjust Range	P _O ≤ 75 W		-20		10	%V _O		
η	Efficiency	I _O = 50% I _O max			91%				
V_R	V _O Ripple (pk-pk)	20 MHz bandwidth			50	100	mV_{pp}		
t _{tr}	Transient Despense	0.1 A/µs slew rate, 50% to 75%	l _O max		150		μs		
ΔV_{tr}	Transient Response	V _O over/undershoot			25		mV		
I _{TRIP}	Overcurrent Threshold	Shutdown, followed by auto-rec	covery		41		Α		
OVP	Output Overvoltage Protection	Output shutdown and latch off		120		%V _O			
OTP	Over Temperature Protection	Temperature Measurement at the nominal.		105		° C			
f_s	Switching Frequency	Over V _I range			300		kHz		
UVLO	Lindon (oltografication)	V _{OFF}	V_I decreasing, $I_O = 6$ A		32.5		V		
UVLO	Undervoltage Lockout	V _{HYS}	Hysteresis		1.5		V		
On/Off In	nput: Negative Enable								
V_{IH}	Input High Voltage	Referenced to -V _I				Open ⁽²⁾	V		
V_{IL}	Input Low Voltage					0.8	v		
I _{IL}	Input Low Current				-0.3		mA		
On/Off In	nput: Positive Enable								
V_{IH}	Input High Voltage	Deferenced to V		4.5		Open ⁽²⁾	V		
V_{IL}	Input Low Voltage	Referenced to -V _I		-0.2		0.8	V		
$I_{\rm IL}$	Input Low Current				-0.5		mA		
I _{ISB}	Standby Input Current	Output disabled (pin 2 status se	et to Off)		37		mA		
C _I	External Input Capacitance	Between +V _I and -V _I			100		μF		
Co	External Output Capacitance	Between +V _O and -V _O		0		30000	μF		
	Isolation Voltage	Input-to-output and input-to-cas	se	1500			Vdc		
	Isolation Capacitance	Input-to-output			1200		pF		
	Isolation Resistance	Input-to-output		10			ΜΩ		

 ⁽¹⁾ If Sense(-) is not used, pin 5 must be connected to pin 4 for optimum output voltage accuracy.
 (2) The Remote On/Off input has an internal pull-up and may be controlled with an open collector (drain) interface. An open circuit correlates to a logic high. Consult the application notes for interface considerations.

NSTRUMENTS

SLTS261C -MAY 2006-REVISED SEPTEMBER 2009

www.ti.com

ELECTRICAL CHARACTERISTICS PTQA430033

(Unless otherwise stated, T_A =25°C, V_I = 48 V, V_O = 3.3 V, C_O = 0 μF , and I_O = I_O max)

	DADAMETED	TEST OF	ONDITIONS	PTQA430033				
	PARAMETER	IESI CC	ONDITIONS	MIN	TYP	MAX	UNIT	
Io	Output Current	Over V _I range		0		30	Α	
VI	Input Voltage Range	Over I _O Range		36	48	75	V	
V _O tol	Set Point Voltage Tolerance				±1 ⁽¹⁾		%V _O	
Reg _{temp}	Temperature Variation	-40°C >T _A > 85°C			±1.15		%V _O	
Reg _{line}	Line Regulation	Over V _I range			±5		mV	
Reg _{load}	Load Regulation	Over I _O range			±5		mV	
ΔV _o tot	Total Output Voltage Variation	Includes set-point, line, load, -4	40°C >T _A > 85°C		±1.5	±3	%V _O	
ΔV_{ADJ}	Output Adjust Range	P _O ≤ 100 W		-20		10	%Vo	
η	Efficiency	I _O = 50% I _O max			92%			
V_R	V _O Ripple (pk-pk)	20 MHz bandwidth			50	100	mV_{pp}	
t _{tr}	Transient Danners	0.1 A/µs slew rate, 50% to 75%	I _O max		150		μs	
ΔV_{tr}	Transient Response	V _O over/undershoot			33		mV	
I _{TRIP}	Overcurrent Threshold	Shutdown, followed by auto-rec	covery		41		Α	
OVP	Output Overvoltage Protection	Output shutdown and latch off		120		%V _O		
OTP	Over Temperature Protection	Temperature Measurement at the nominal.	Temperature Measurement at thermal sensor. Hysteresis = 10°C nominal.				°C	
f_s	Switching Frequency	Over V _I range			300		kHz	
UVLO	Lindom rolto ao Lookovit	V _{OFF}	V _I decreasing, I _O = 6 A		32.5		V	
0 VLO	Undervoltage Lockout	V _{HYS}	Hysteresis		1.5		v	
On/Off Ir	nput: Negative Enable							
V_{IH}	Input High Voltage	Deferenced to V				Open ⁽²⁾	V	
V_{IL}	Input Low Voltage	Referenced to -V _I		-0.2		0.8	v	
I _{IL}	Input Low Current				-0.3		mA	
On/Off Ir	nput: Positive Enable							
V_{IH}	Input High Voltage	Potoropood to V		4.5		Open ⁽²⁾	V	
V_{IL}	Input Low Voltage	Referenced to -V _I		-0.2		0.8	v	
I_{IL}	Input Low Current				-0.5		mA	
I _{Isb}	Standby Input Current	Output disabled (pin 2 status se	et to Off)		42		mA	
C _I	External Input Capacitance	Between +V _I and -V _I			100		μF	
C _O	External Output Capacitance	Between +V _O and -V _O		0		30000	μF	
	Isolation Voltage	Input-to-output and input-to-cas	se	1500			Vdc	
	Isolation Capacitance	Input-to-output			1200		pF	
	Isolation Resistance	Input-to-output		10			ΜΩ	

Submit Documentation Feedback

 ⁽¹⁾ If Sense(-) is not used, pin 5 must be connected to pin 4 for optimum output voltage accuracy.
 (2) The Remote On/Off input has an internal pull-up and may be controlled with an open collector (drain) interface. An open circuit correlates to a logic high. Consult the application notes for interface considerations.



www.ti.com

SLTS261C -MAY 2006-REVISED SEPTEMBER 2009

ELECTRICAL CHARACTERISTICS PTQA420050

(Unless otherwise stated, T_A =25°C, V_I = 48 V, V_O = 5.0 V, C_O = 0 μF , and I_O = I_O max)

	PARAMETER	TEST CONDITIONS			PTQA420050				
	FARAIVIE I EK	151 00	פאטוווטאט	MIN	TYP	MAX	UNIT		
Io	Output Current	Over V _I range		0		20	Α		
VI	Input Voltage Range	Over I _O Range		36	48	75	V		
V _O tol	Set Point Voltage Tolerance				±1 ⁽¹⁾		%V _O		
Reg _{temp}	Temperature Variation	-40°C >T _A > 85°C			±1.15		%V _O		
Reg _{line}	Line Regulation	Over V _I range			±5		mV		
Reg _{load}	Load Regulation	Over I _O range			±5		mV		
ΔV_{o} tot	Total Output Voltage Variation	Includes set-point, line, load, -4	40°C >T _A > 85°C		±1.5	±3	%V _O		
ΔV_{ADJ}	Output Adjust Range	P _O ≤ 100 W		-20		10	%V _O		
η	Efficiency	I _O = 50% I _O max			92.5%				
V_R	V _O Ripple (pk-pk)	20 MHz bandwidth			50	100	mV_{pp}		
t _{tr}	Transient Despense	0.1 A/µs slew rate, 50% to 75%	o I _O max		100		μs		
ΔV_{tr}	Transient Response	V _O over/undershoot			50		mV		
I _{TRIP}	Overcurrent Threshold	Shutdown, followed by auto-red	covery		29		Α		
OVP	Output Overvoltage Protection	Output shutdown and latch off		120		%V _O			
OTP	Over Temperature Protection	Temperature Measurement at t nominal.		105		° C			
fs	Switching Frequency	Over V _I range			300		kHz		
111/1/0	l la deminita de la calcació	V _{OFF}	V _I decreasing, I _O = 6 A		32.5		\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
UVLO	Undervoltage Lockout	V _{HYS}	Hysteresis		1.5		V		
On/Off Ir	nput: Negative Enable								
V_{IH}	Input High Voltage	Defendant to M			2.4 Op	Open ⁽²⁾	V		
V_{IL}	Input Low Voltage	Referenced to -V _I		-0.2		0.8	V		
I _{IL}	Input Low Current				-0.3		mA		
On/Off Ir	nput: Positive Enable								
V_{IH}	Input High Voltage	Defended to V		4.5		Open ⁽²⁾	V		
V_{IL}	Input Low Voltage	Referenced to -V _I		-0.2		0.8	V		
$I_{\rm IL}$	Input Low Current				-0.5		mA		
I _{Isb}	Standby Input Current	Output disabled (pin 2 status se	et to Off)		58		mA		
C _I	External Input Capacitance	Between +V _I and -V _I			100		μF		
Co	External Output Capacitance	Between +V _O and -V _O		0		30000	μF		
	Isolation Voltage	Input-to-output and input-to-cas	se	1500			Vdc		
	Isolation Capacitance	Input-to-output			1200		pF		
	Isolation Resistance	Input-to-output		10			ΜΩ		

⁽¹⁾ If Sense(-) is not used, pin 5 must be connected to pin 4 for optimum output voltage accuracy.

⁽²⁾ The Remote On/Off input has an internal pull-up and may be controlled with an open collector (drain) interface. An open circuit correlates to a logic high. Consult the application notes for interface considerations.

www.ti.com

PIN DESCRIPTIONS

+ V_i : The positive input for the module with respect to $-V_i$. When powering the module from a -48-V telecom central office supply, this input is connected to the primary system ground.

-V_i: The negative input supply for the module, and the 0 VDC reference for the Remote On/Off input. When powering the module from a +48-V supply, this input is connected to the 48-V return.

Remote On/Off: This input controls the On/Off status of the output voltage. It is either driven low $(-V_1)$ potential, or left open-circuit. For units identified with the NEN option, applying a logic low to this pin will enable the output. And for units identified with the PEN option, the output will be disabled.

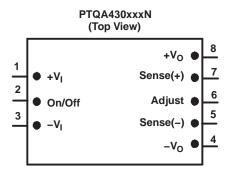
 V_0 Adjust: Allows the output voltage to be trimmed by up or down between +10% and -20% of its nominal value. The adjustment method uses a single external resistor. Connecting the resistor between V_0 Adjust and $-V_0$ adjusts the output voltage lower, and placing it between V_0 Adjust and $+V_0$ adjusts the output higher. The calculations for the resistance value follows industry standard formulas. For further information consult the application note on output voltage adustment.

+V_O: The positive power output with respect to $-V_O$, which is DC isolated from the input supply pins. If a negative output voltage is desired, $+V_O$ should be connected to the secondary circuit common and the output taken from $-V_O$.

 $-\mathbf{V}_{O}$: The negative power output with respect to $+\mathbf{V}_{O}$, which is DC isolated from the input supply pins. This output is normally connected to the secondary circuit common when a positive output voltage is desired.

Sense(+): Provides the converter with an output sense capability to regulate the set-point voltage directly at the load. When used with Sense(-), the regulation circuitry will compensate for voltage drop between the converter and the load. The pin may be left open circuit, but connecting it to +V_O improves load regulation.

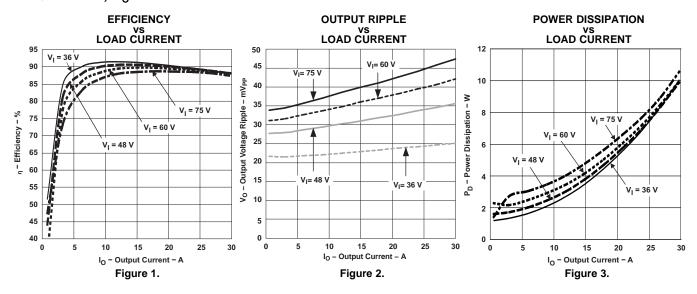
Sense(–): Provides the converter with an output sense capability when used in conjunction with Sense(+) input. For optimum output voltage accuracy this pin should always be connected to $-V_0$.



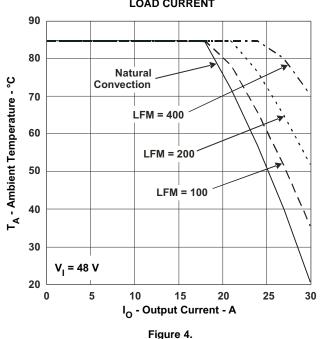


TYPICAL CHARACTERISTICS

PTQA430025, $V_0 = 2.5 V^{(1)}$ (2)



AMBIENT TEMPERATURE VS LOAD CURRENT

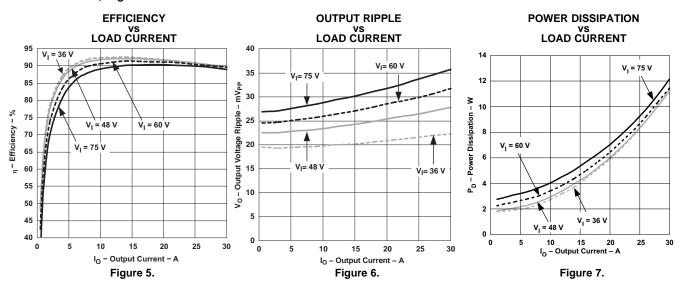


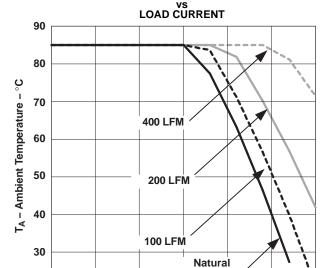
- (1) All data listed in Figure 1, Figure 2, and Figure 3 have been developed from actual products tested at 25°C. This data is considered typical data for the dc-dc converter.
- (2) The temperature derating curves represent operating conditions at which internal components are at or below manufacturer's maximum rated operating temperature. Derating limits apply to modules soldered directly to a 100–mm × 100–mm, double-sided PCB with 2 oz. copper. For surface mount packages, multiple vias (plated through holes) are required to add thermal paths around the power pins. Please refer to the mechanical specification for more information. Applies to Figure 4.



TYPICAL CHARACTERISTICS

PTQA430033, $V_0 = 3.3 V^{(1)}$ (2)





Convection

20

25

30

15

I_O – Output Current – A Figure 8.

AMBIENT TEMPERATURE

(1) All data listed in Figure 5, Figure 6, and Figure 7 have been developed from actual products tested at 25°C. This data is considered typical data for the dc-dc converter.

 $V_1 = 48 V$

5

20

0

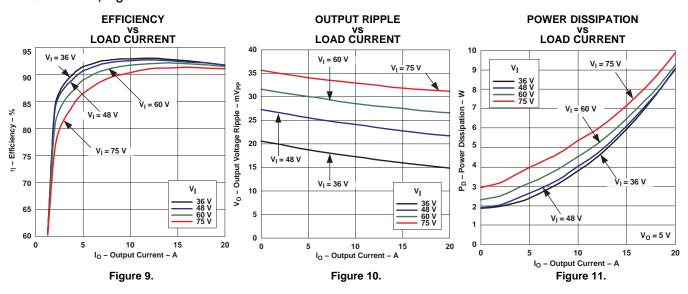
(2) The temperature derating curves represent operating conditions at which internal components are at or below manufacturer's maximum rated operating temperature. Derating limits apply to modules soldered directly to a 100–mm x 100–mm, double-sided PCB with 2 oz. copper. For surface mount packages, multiple vias (plated through holes) are required to add thermal paths around the power pins. Please refer to the mechanical specification for more information. Applies to Figure 8.



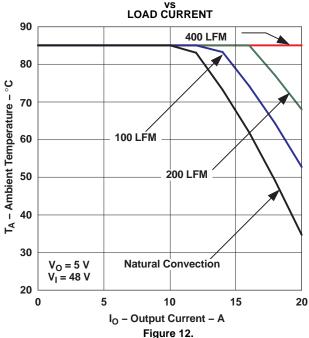
TYPICAL CHARACTERISTICS

PTQA420050, $V_0 = 5.0 V^{(1)}$ (2)

INSTRUMENTS







- All data listed in Figure 9, Figure 10, and Figure 11 have been developed from actual products tested at 25°C. This data is considered typical data for the dc-dc converter.
- The temperature derating curves represent operating conditions at which internal components are at or below manufacturer's maximum rated operating temperature. Derating limits apply to modules soldered directly to a 100-mm x 100-mm, double-sided PCB with 2 oz. copper. For surface mount packages, multiple vias (plated through holes) are required to add thermal paths around the power pins. Please refer to the mechanical specification for more information. Applies to Figure 12.

www.ti.com

APPLICATION INFORMATION

Operating Features and System Considerations for the PTQA Series of DC/DC Converters

Overcurrent Protection

To protect against load faults, these converters incorporate output overcurrent protection. Applying a load to the output that exceeds the converter's overcurrent threshold (see applicable specification) will cause the output voltage to momentarily fold back, and then shut down. Following shutdown the module will periodically attempt to automatically recover by initiating a soft-start power-up. This is often described as a hiccup mode of operation, whereby the module continues in the cycle of successive shutdown and power up until the load fault is removed. Once the fault is removed, the converter automatically recovers and returns to normal operation.

Output Overvoltage Protection

Each converter incorporates protection circuitry that continually senses for an output overvoltage (OV) condition. The OV threshold is set approximately 20% higher than the nominal output voltage. If the converter output voltage exceeds this threshold, the converter is immediately shut down and remains in a latched-off state. To resume normal operation the converter must be actively reset. This can only be done by momentarily removing the input power to the converter. For fail-safe operation and redundancy, the OV protection uses circuitry that is independent of the converter's internal feedback loop.

Overtemperature Protection

Overtemperature protection is provided by an internal temperature sensor, which closely monitors the temperature of the converter's printed circuit board (PCB). If the sensor exceeds a temperature of approximately 105°C, the converter will shut down. The converter will then automatically restart when the sensed temperature drops back to approximately 95°C. When operated outside its recommended thermal derating envelope (see data sheet SOA curves), the converter will typically cycle on and off at intervals from a few seconds to one or two minutes. This is to ensure that the internal components are not permanently damaged from excessive thermal stress.

Undervoltage Lockout

The Undervoltage lockout (UVLO) is designed to prevent the operation of the converter until the input voltage is at the minimum input voltage. This prevents high start-up current during normal power-up of the converter, and minimizes the current drain from the input source during low input voltage conditions. The UVLO circuitry also overrides the operation of the Remote On/Off control.

Primary-Secondary Isolation

These converters incorporate electrical isolation between the input terminals (primary) and the output terminals (secondary). All converters are production tested to a withstand voltage of 1500 VDC. This specification complies with UL60950 and EN60950 requirements. This allows the converter to be configured for either a positive or negative input voltage source. The data sheet Pin Descriptions section provides guidance as to the correct reference that must be used for the external control signals.

Input Current Limiting

The converter is not internally fused. For safety and overall system protection, the maximum input current to the converter must be limited. Active or passive current limiting can be used. Passive current limiting can be a fast acting fuse. A 125-V fuse, rated no more than 10 A, is recommended. Active current limiting can be implemented with a current limited *Hot-Swap* controller.

Thermal Considerations

Airflow may be necessary to ensure that the module can supply the desired load current in environments with elevated ambient temperatures. The required airflow rate may be determined from the Safe Operating Area (SOA) thermal derating chart (see typical characteristics).

Submit Documentation Feedback

Not Recommended for New Designs



PTQA430025, PTQA430033, PTQA420050

www.ti.com

SLTS261C -MAY 2006-REVISED SEPTEMBER 2009

Differential Remote Sense

The remote sense pins allows the converter to precisely regulate the DC output voltage at a remote location. This might be a power plane on an inner layer of the host PCB. Connecting Sense(+) directly to $+V_O$, and Sense(-) to $-V_O$ will improve output voltage accuracy. In the event that the sense pins are left open-circuit, an internal $10-\Omega$ resistor between each sense pin and its corresponding output prevents an excessive rise in the output voltage. For practical reasons, the amount of IR voltage compensation should be limited to 0.5 V maximum.

The remote sense feature is designed to compensate for limited amounts of *IR* voltage drop. It is **not** intended to compensate for the forward drop of a non-linear or frequency dependent components that may be placed in series with the converter output. Examples of such components include OR-ing diodes, filter inductors, ferrite beads, and fuses. Enclosing these components with the remote sense connections effectively places them inside the regulation control loop, which can affect the stability of the regulator.

www.ti.com

Using the Remote On/Off Function on the PTQA Series of DC/DC Converters

For applications requiring output voltage On/Off control, the PTQA series of DC/DC converters incorporate a Remote On/Off control (pin 2). This feature can be used to switch the module off without removing the applied input source voltage. When placed in the Off state, the standby current drawn from the input source is typically reduced to 3 mA.

Negative Output Enable (NEN)

Models using the negative enable option, the *Remote On/Off* (pin 2) control must be driven to a logic low voltage for the converter to produce an output. This is accomplished by either permanently connecting pin 2 to $-V_1$ (pin 3), or driving it low with an external control signal. Table 2 shows the input requirements of pin 2 for those modules with the *NEN* option.

Table 2. On/Off Control Requirements for Negative Enable

	PARAMETER	MIN	TYP	MAX
V_{IH}	Disable	2.4 V		20 V
V _{IL}	Enable	-0.2 V		0.8 V
V _{o/c}	Open-Circuit		9 V	15 V
I_{\parallel}	Pin 2 at -V ₁			−0.75 mA

Positive Output Enable (PEN)

For those models with the positive enable (PEN) option, leaving pin 2 open circuit, (or driving it to an equivalent logic high voltage), will enable the converter output. This allows the module to produce an output voltage whenever a valid input source voltage is applied to $+V_1$ with respect to $-V_1$. If a logic-low signal is then applied to pin 2 the converter output is disabled. Table 3 gives the input requirements of pin 2 for modules with the *PEN* option.

Table 3. On/Off Control Requirements for Positive Enable

	PARAMETER	MIN	TYP	MAX
V_{IH}	Enable	4.5 V		20 V
V_{IL}	Disable	-0.2 V		0.8 V
V _{o/c}	Open-Circuit		5 V	7 V
I _I	Pin 2 at -V _I			–0.5 mA

Notes:

- 1. The Remote On/Off control uses $-V_1$ (pin 3) as its ground reference. All voltages are with respect to $-V_1$.
- 2. An open-collector device (preferably a discrete transistor) is recommended. A pull-up resistor is not required. If one is added the pull-up voltage should not exceed 20 V.

Caution: Do not use a pull-resistor to $+V_1$ (pin 1). The remote On/Off control has a maximum input voltage of 20 V. Exceeding this voltage will overstress, and possibly damage, the converter.

- 3. The *Remote On/Off* pin may be controlled with devices that have a totem-pole output. This is provided the output high level voltage (V_{OH}) meets the module's minimum V_{IH} specified in Table 2. If a TTL gate is used, a pull-up resistor may be required to the logic supply voltage.
- 4. The converter incorporates an *undervoltage lockout* (UVLO). The UVLO keeps the converter off until the input voltage is close to the minimum specified operating voltage. This is regardless of the state of the *Remote On/Off* control. Consult the product specification for the UVLO input voltage thresholds.

2 Submit Documentation Feedback

www.ti.com

SLTS261C -MAY 2006-REVISED SEPTEMBER 2009

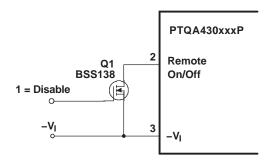


Figure 13. Recommended Control or Remote On/Off Input

Turn-On: With a valid input source voltage applied, the converter produces a regulated output voltage within 75 ms of the output being enabled. Figure 14 shows the output response of the PTQA430033P following the removal of the logic-low signal from the *Remote On/Off* (pin 2); see Figure 13. This corresponds to the drop in Q1 V_{GS} in Figure 14. Although the rise-time of the output voltage is short (<10 ms), the indicated delay time will vary depending upon the input voltage and the module's internal timing. The waveforms were measured with 48 VDC input voltage, and a 10-A resistive load.

Turn-Off Time: When a valid input source is removed or if the *Remote On/Off* (pin 2) is used to disable the output, with no external output capacitance, the module powers down within 200 μs. Figure 15 shows that, during power down, there is a small undershoot, typically less than 300 mV (or less than a diode drop). If used to supply processor I/O voltages, the low undershoot ensures the parasitic diodes do not conduct current and potentially cause damage to external circuitry.

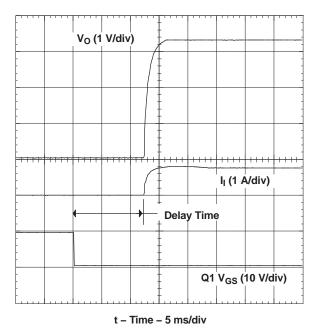


Figure 14. Power Up

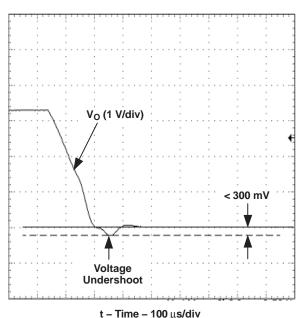


Figure 15. Power Down

INSTRUMENTS

www.ti.com

Adjusting the Output Voltage of the 100-W Rated PTQA Series of Isolated DC/DC Converters

The output voltage adjustment of the PTQA series of isolated DC/DC converters follows the standard adopted by popular 1/4-brick DC/DC converters. Adjustment is accomplished with a single external resistor that can adjust the output voltage from -20% to +10% of the nominal set-point voltage. The placement of the resistor determines the direction of adjustment, up or down, and the value of the magnitude of adjustment.

Adjust Up: To increase the output voltage add a resistor, R1, between V_0 Adjust (pin 6) and Sense(+) (pin 7).

Adjust Down: Add a resistor, (R2), between V_O Adjust (pin 6) and Sense(–) (pin 5).

Refer to Figure 16 for the placement of the required resistor, R1 or (R2).

The values of R1 [adjust up], and (R2) [adjust down], can be calculated using the following formulas or selected

$$R1 = \frac{5.11 \text{ V}_{\text{O}} (100 + \Delta\%)}{1.225 \Delta\%} - \frac{511}{\Delta\%} - 10.22 \text{ (k}\Omega)$$
(1)

$$(R2) = 5.11 \frac{100}{\Delta\%} - 10.22 \quad (k\Omega)$$
 (2)

Where:

 Δ % = Amount of adjustment in %

V_O = Original set-point voltage

Notes:

- 1. Use only a single 1% resistor in either the R1 or (R2) location. Place the resistor as close to the converter as
- 2. If the output voltage is increased, the maximum load current must be derated according to the following equation.

$$I_{O}(max) = \frac{V_{O} \times I_{O}(rated)}{V_{A}}$$
(3)

Where:

V_O = Original set-point voltage

V_A = Adjusted output voltage (measured between pins 8 and 4)

In any instance, the load current must not exceed the converter's maximum rated output current of 30 A.

3. The overvoltage threshold is fixed, and is set approximately 20% above the nominal output voltage. Adjusting the output voltage higher reduces the voltage margin between the adjusted output voltage and the overvoltage (OV) protection threshold. This could make the module sensitive to OV fault detection, as a result of random noise and load transients.

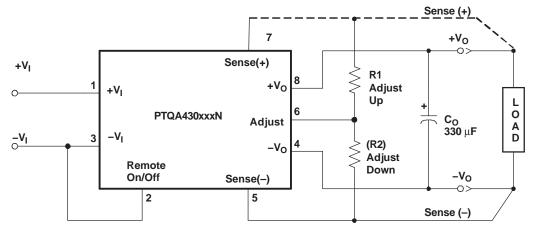


Figure 16.



www.ti.com

SLTS261C -MAY 2006-REVISED SEPTEMBER 2009

Table 4. Standard Adjustment Resistor Values

	Adjust	ted Output Volta		Trim-Up R _{AD}	J	Trim-Down R _{ADJ}			
V _O (nom) % Adjust (V)	5.0 V	3.3 V	2.5 V	5.0 V R1 (kΩ)	3.3 V R1 (kΩ)	2.5 V R1 (kΩ)	5.0 V R2 (kΩ)	3.3 V R2 (kΩ)	2.5 V R2 (kΩ)
+10	5.50	3.630	2.750	169	90.9	53.6	-	-	-
+ 9	5.45	3.597	2.725	187	100	59.0	-	-	-
+ 8	5.40	3.564	2.700	205	113	66.5	-	-	-
+ 7	5.35	3.531	2.675	237	127	76.8	-	-	-
+ 6	5.30	3.498	2.650	274	147	88.7	-	-	-
+ 5	5.25	3.465	2.625	324	178	107	-	-	-
+ 4	5.20	3.432	2.600	402	221	133	-	-	-
+ 3	5.15	3.399	2.575	536	294	178	-	-	-
+ 2	5.10	3.366	2.550	787	432	267	-	-	-
+ 1	5.05	3.333	2.525	1580	866	536	-	-	-
0	5.00	3.300	2.500	Open	Open	Open	-	-	-
-1	4.95	3.267	2.475	-	-	-	499	499	499
-2	4.90	3.234	2.450	-	-	-	243	243	243
-3	4.85	3.201	2.425	-	-	-	158	158	158
-4	4.80	3.168	2.400	-	-	-	118	118	118
-5	4.75	3.135	2.375	-	-	-	90.9	90.9	90.9
-6	4.70	3.102	2.350	-	-	-	75	75	75
-7	4.65	3.069	2.325	-	-	-	63.4	63.4	63.4
-8	4.60	3.036	2.300	-	-	-	53.6	53.6	53.6
-9	4.55	3.003	2.275	-	-	-	46.4	46.4	46.4
-10	4.50	2.970	2.250	-	-	-	41.2	41.2	41.2
-11	4.45	2.937	2.225	-	-	-	36.5	36.5	36.5
-12	4.40	2.904	2.200	-	-	-	32.4	32.4	32.4
-13	4.35	2.871	2.175	-	-	-	28.7	28.7	28.7
-14	4.30	2.838	2.150	-	-	-	26.1	26.1	26.1
-15	4.25	2.805	2.125	-	-	-	23.7	23.7	23.7
-16	4.20	2.772	2.100	-	-	-	21.5	21.5	21.5
-17	4.15	2.739	2.075	-	-	-	19.6	19.6	19.6
-18	4.10	2.706	2.050	-	-	-	18.2	18.2	18.2
-19	4.05	2.673	2.025	-	-	-	16.5	16.5	16.5
-20	4.00	2.640	2.000	-	-	-	15.4	15.4	15.4

Copyright © 2006–2009, Texas Instruments Incorporated

Submit Documentation Feedback

www.ti.com 11-Nov-2025

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
PTQA420050N2AD	NRND	Production	Through-Hole Module (EAP) 8	9 TIW TRAY	In-Work	SN	N/A for Pkg Type	-40 to 85	
PTQA420050N2AD.B	NRND	Production	Through-Hole Module (EAP) 8	9 TIW TRAY	In-Work	SN	N/A for Pkg Type	-40 to 85	
PTQA420050N2AS	NRND	Production	Surface Mount Module (EAQ) 8	9 TIW TRAY	No	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85	
PTQA420050N2AZ	NRND	Production	Surface Mount Module (BAQ) 8	9 TIW TRAY	In-Work	SNAGCU	Level-3-260C-168 HR	-40 to 85	
PTQA420050P2AD	NRND	Production	Through-Hole Module (EAP) 8	9 TIW TRAY	In-Work	SN	N/A for Pkg Type	-40 to 85	
PTQA420050P2AD.B	NRND	Production	Through-Hole Module (EAP) 8	9 TIW TRAY	In-Work	SN	N/A for Pkg Type	-40 to 85	
PTQA420050P2AS	NRND	Production	Surface Mount Module (EAQ) 8	9 TIW TRAY	No	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85	
PTQA420050P2AZ	NRND	Production	Surface Mount Module (BAQ) 8	9 TIW TRAY	In-Work	SNAGCU	Level-3-260C-168 HR	-40 to 85	
PTQA430033N2AD	NRND	Production	Through-Hole Module (EAP) 8	9 TIW TRAY	In-Work	SN	N/A for Pkg Type	-40 to 85	
PTQA430033N2AD.B	NRND	Production	Through-Hole Module (EAP) 8	9 TIW TRAY	In-Work	SN	N/A for Pkg Type	-40 to 85	

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

www.ti.com 11-Nov-2025

(5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

DOUBLE SIDED MODULE BAQ (R-PDSS-B8) - 2.22 (56,39) 0.495 0.110 (12,57)2.000 (50,80) (2,79)MAX. Note J 0.43 (10,90)8 • Solder Ball 0.300 Ø0.040 (1,02) (7,62) 0.600 1.45 PX000000X 0.150 8 Places (36,83)• 0.600 (15,24) — (3,81) 4 Places See Note I. xxx **₹** • DATE CODE **•** 3 4 • TOP VIEW SIDE VIEW 2.260 (57,40) 0.130. - 2.000 (50,80) (3,30)Lowest Component 0.010 MIN. (0,25) 0.45 Bottom side (11,43)Clearance 0.300 (7,62) 0.600 0.150 (15,24) 1.490 — (3,81) 4 Places (37,85)Host Board Ø0.085 (2,16) 8 Places See Note F, G & H Note E -

NOTES: Α. All linear dimensions are in inches (mm).

- This drawing is subject to change without notice.
- 2 place decimals are ± 0.020 ($\pm 0,51$ mm). 3 place decimals are ± 0.010 ($\pm 0,25$ mm).
- Recommended keep out area for user components.
- Power pin connection should utilize four or more vias to the interior power plane of 0.025 (0,63) I.D. per input, ground and output pin (or the electrical equivalent).

PCB Layout

G. Paste screen opening: 0.080 (2,03) to 0.085 (2,16). Paste screen thickness: 0.006 (0,15).

0.472 (12,00)

MAX.

- H. Pad type: Solder mask defined.
- I. All pins: Material Copper Alloy Finish Tin (100%) over Nickel plate Solder Ball 96.5 Sn/3.0 Ag/0.5 Cu

4207714/A 02/06

J. Dimension prior to reflow solder.



DOUBLE SIDED MODULE EAP (R-PDSS-T8) - 2.22 (56,39) -0.140 0.110 (3,55)2.000 (50,80) (2,79)Ø0.060 (1,52) 2 Places (10,90)Note F, G. 8 • 0.300 Ø0.040 (1,02) (7,62) 0.600 PXXXXXXX 0.150 1.45 -6 Places 0.600 15,24) • - (3,81) 4 Places (36,83)Note G, H. XXX T 0 DATE CODE **•** 3 40 Lowest Component(0,25) 0.010 MIN. Bottom side TOP VIEW Clearance Host Board 0.472 (12,00)MAX. 2.260 (57,40) SIDE VIEW 0.130 2.000 (50,80) (3,30)Note E -0.45 (11,43)8**0** 0.300 0.600 (7,62) 0 0.150 0 0 (15,24) 1.490 - (3,81) 4 Places (37,85)0 4**Q** Ø0.086 (2,20) Min. 2 Places Plated through hole. Ø0.055 (1,40) Min. 6 Places Plated through hole. 4207562/A 12/05 PCB Layout

- NOTES:
- A. All linear dimensions are in inches (mm).
- This drawing is subject to change without notice.
- C. 2 place decimals are ± 0.020 (± 0.51 mm).
- D. 3 place decimals are ± 0.010 (± 0.25 mm).
- E. Recommended keep out area for user components.
- Pins are 0.060" (1,52) diameter with 0.125" (3,20) diameter standoff shoulder.
- G. All pins: Material Copper Alloy
 Finish Tin (100%) over Nickel plate

 H. Pins are 0.040" (1,02) diameter with
 0.070" (1,78) diameter standoff shoulder.



EAQ (R-PDSS-B8) DOUBLE SIDED MODULE - 2.22 (56,39) 0.495 0.110 (12,57)- 2.000 (50,80) (2,79)MAX. Note J 0.43 (10,90)8 • Solder Ball 0.300 Ø0.040 (1,02) (7,62) 0.600 1.45 0.150 8 Places (36,83)• 0.600 (15,24) - (3,81) 4 Places See Note I. • **•** 3 4 • TOP VIEW SIDE VIEW 2.260 (57,40) 0.130. - 2.000 (50,80) (3,30)Lowest Component 0.010 MIN. (0,25) 0.45 Bottom side (11,43)Clearance 0.300 (7,62) 0.600 0.150 (15,24) 1.490 — (3,81) 4 Places (37,85)Host Board Ø0.085 (2,16) 8 Places See Note F, G & H Note E -0.472 (12,00)PCB Layout MAX. 4207563/A 12/05

NOTES: Α. All linear dimensions are in inches (mm).

- This drawing is subject to change without notice.
- 2 place decimals are ± 0.020 ($\pm 0,51$ mm). 3 place decimals are ± 0.010 ($\pm 0,25$ mm).
- Recommended keep out area for user components.
- Power pin connection should utilize four or more vias to the interior power plane of 0.025 (0,63) I.D. per input, ground and output pin (or the electrical equivalent).
- G. Paste screen opening: 0.080 (2,03) to 0.085 (2,16). Paste screen thickness: 0.006 (0,15).
- H. Pad type: Solder mask defined.
- I. All pins: Material Copper Alloy
 Finish Tin (100%) over Nickel plate
 Solder Ball See product data sheet.

J. Dimension prior to reflow solder.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale, TI's General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025